## High Frequency 50 GHz Thin Film Chip Resistor



DESIGN SUPPORT TOOLS
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## $3 D$ <br> Models <br> Available

Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz .

## FEATURES

- Operating frequency 50 GHz
- Thin film microwave resistors
- Flip chip, wraparound or one face termination
- Small size, down to 20 mils by 16 mils
- Edged trimmed block resistors
- Pure alumina substrate (99.5 \%)
- Ohmic range: 10R to 500R
- Design kits available
- Small internal reactance (LC down to $1 \times 10^{-24}$ )
- Tolerance 1 \%, 2 \%, 5 \%, 10 \%
- TCR: $100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ in $\left(-55^{\circ} \mathrm{C},+155^{\circ} \mathrm{C}\right)$ temperature range
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


## STANDARD ELECTRICAL SPECIFICATIONS

| MODEL | SIZE | RESISTANCE <br> RANGE <br> $\Omega$ | RATED POWER <br> $\mathbf{P n}$ <br> $\mathbf{W}$ | LIMITING ELEMENT <br> VOLTAGE <br> $\mathbf{V}$ | TOLERANCE <br> $\mathbf{\pm} \%$ | TEMPERATURE <br> COEFFICIENT <br> $\mathbf{\pm p p m} /{ }^{\circ} \mathbf{C}$ |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| CH 02016 | 02016 | 10 to 500 | 0.030 | 30 | $2,5,10$ | 100 |
| CH 0402 | 0402 | 10 to 500 | 0.050 | 37 | $1,2,5,10$ | 100 |
| CH 0603 | 0603 | 10 to 500 | 0.125 | 50 | $1.2,5,10$ | 100 |

## DIMENSIONS in millimeters (inches)



## Note

(1) $\pm 0.070( \pm 0.003)$

## TOLERANCE VS. OHMIC VALUES

| Ohmic range | $10 \Omega \leq R<50 \Omega$ | $50 \Omega \leq R<100 \Omega$ | $100 \Omega \leq R \leq 500 \Omega$ |
| :--- | :---: | :---: | :---: |
| Tolerance | $5 \%, 10 \%$ | $2 \%, 5 \%, 10 \%$ | $1 \%, 2 \%, 5 \%, 10 \%(1)$ |

## Note

(1) $1 \%$ tolerance not applicable for case 02016

## LAND PATTERN FOR F 'FLIP CHIP' TERMINATIONS in millimeters (inches)



| CHIP SIZE | $\mathbf{Z}_{\text {max. }}$ | $\mathbf{X}_{\text {max. }}$ | $\mathbf{G}_{\text {min. }}$ |
| :--- | :---: | :---: | :---: |
| 02016 | $0.53(0.021)$ | $0.44(0.017)$ | $0.15(0.006)$ |
| 0402 | $1.40(0.055)$ | $0.65(0.026)$ | $0.40(0.016)$ |
| 0603 | $1.71(0.067)$ | $0.90(0.035)$ | $0.76(0.030)$ |

## Note

- Suggested land pattern: According to IPC-7351

LAND PATTERN FOR N AND G WRAPAROUND TERMINATIONS in millimeters (inches)

| $\mathrm{G}_{\text {min }}$. |  |  |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{Z}_{\text {max }}$ |  |  |  |
| CHIP SIZE | $\mathbf{Z}_{\text {max }}$ | $\mathrm{G}_{\text {min. }}$ | $\mathrm{X}_{\text {max }}$. |
| 0402 | 1.55 (0.061) | 0.15 (0.006) | 0.73 (0.029) |
| 0603 | 2.37 (0.093) | 0.35 (0.014) | 0.98 (0.039) |

Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard"

## PREFERRED MODELS AND VALUES

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances.
Recommended Values:
10R/18R/25R/50R/75R/100R/150R/180R/200R/250R/330R/500R
Those values are available with a MOQ of $\mathbf{1 0 0}$ pieces.
Other values can be ordered upon request, but higher MOQ will apply: 1000 pieces for $\mathbf{C H 0 2 0 1 6 , 5 0 0}$ pieces for CH0402, 50 pieces for CH 0603.
Recommended termination:
F
Recommended tolerance:
2 \%

## DESIGN KITS

Design kits are available Ex Stock in CH 02016 and CH 0402 sizes. There are 20 pieces per recommended value. F termination. 5 \% tolerance.
Those kits are packaged in pieces of tape and delivered in ESD bags.

## PACKAGING

Standard packaging is waffle pack for sizes 0402 and 0603 and plastic tape and reel (low conductivity) for size 02016.
Paper tape and reel is available for size 0402 and either paper tape and reel or plastic tape and reel (low conductivity) for size 0603.

Depending on the type of terminations, parts will be packed differently:
One face:

- Gold terminations: Active face up
- Tin/silver termination: Active face down


## Note

- Please refer to Vishay Sfernice Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Products" for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies

| SIZE | MOQ | NUMBER OF PIECES PER PACKAGE |  |  | TAPE WIDTH |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | WAFFLE PACK 2" X 2" | TAPE AND REEL |  |  |
|  |  |  | Min. | Max. |  |
| 02016 | See MOQ mentioned on preferred models and values | 484 | 100 | 5000 | 8 mm |
| 0402 |  | 100 |  |  |  |
| 0603 |  | 100 |  |  |  |

## PACKAGING RULES

## Waffle Pack

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover. To get "not stacked up" waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

## Tape and Reel

See Part Numbering information to get the quantity desired by tape.
In regard to the CH02016 size only, up to 5 empty cavities can be found every 1000 parts in the reel. Nevertheless, the number of requested parts will be respected.

## GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: CH0402-50RJF (preferred part number format)


## Notes

- Historical part numbers are not recommended but can still be used for ordering
${ }^{(1)}$ Gold termination for application in hermetic package
(2) CHKIT for 0603 size is not available

| CODIFICATION OF PACKAGING |  |
| :---: | :---: |
| WAFFLE PACK (standard packaging for CH0402 and CH0603) |  |
| W | 100 min., 1 mult |
| PLASTIC TAPE (standard packaging for CH02016 and CH0603) |  |
| T | 100 min., 1 mult |
| TA | 100 min., 100 mult |
| TB | 250 min., 250 mult |
| TC | 500 min., 500 mult |
| TD | 1000 min., 1000 mult |
| TE | 2500 min., 2500 mult |
| TF | Full tape (quantity depending on size of chips) |
| PAPER TAPE (standard packaging for CH0402-available for CH0603) |  |
| PT | 100 min., 1 mult |
| PA | 100 min., 100 mult |
| PB | 250 min., 250 mult |
| PC | 500 min., 500 mult |
| PD | 1000 min., 1000 mult |
| PE | 2500 min., 2500 mult |
| PF | Full tape (quantity depending on size of chips) |

## TYPICAL HIGH FREQUENCY PERFORMANCE ELECTRICAL MODEL

|  |  |  |
| :---: | :---: | :---: |
| C |  | Internal shunt capacitance |
| L |  | Internal inductance |
| R |  | Resistance |
| Z |  | Internal impedance (R, L, C) |
| $\mathrm{L}_{\mathrm{c}}$ |  | External connection inductance |
| $\mathrm{C}_{\mathrm{g}}$ |  | External capacitance to ground |

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The complex impedance of the chip resistor is given by the following equations:

## Notes

$$
\begin{gathered}
\mathrm{Z}=\frac{R+\mathrm{j} \omega\left(\mathrm{~L}-R^{2} \mathrm{C}-\mathrm{L}^{2} \mathrm{C} \omega^{2}\right)}{1+\mathrm{C}\left[\left(R^{2} \mathrm{C}-2 \mathrm{~L}\right) \omega^{2}+\mathrm{L}^{2} \mathrm{C} \omega^{4}\right]} \\
\frac{[\mathrm{Z}]}{R}=\frac{1}{1+\mathrm{C}\left[\left(R^{2} \mathrm{C}-2 \mathrm{~L}\right) \omega^{2}+\mathrm{L}^{2} \mathrm{C} \omega^{4}\right]} \times \sqrt{1+\left[\frac{\omega\left(\mathrm{L}-R^{2} \mathrm{C}-\mathrm{L}^{2} \mathrm{C} \omega^{2}\right)}{R}\right]^{2}} \\
\theta=\tan ^{-1} \frac{\omega\left(\mathrm{~L}-R^{2} \mathrm{C}-\mathrm{L}^{2} \mathrm{C} \omega^{2}\right)}{R}
\end{gathered}
$$

- $\omega=2 \mathrm{x} \pi \mathrm{xf}$
- $f$ : Frequency

The chip resistor itself is purely resistive when $R=\sqrt{\frac{L}{C}}$. The smaller the $L \times C$ product the greater the frequency range over which the resistor looks approximately resistive.
This can be seen on the graphs showing the ratio $\frac{[Z]}{R}$ versus frequency.
$R, L$ and $C$ are relevant to the chip resistor itself.
$L_{c}$ and $\mathrm{C}_{\mathrm{g}}$ also depends on the way the chip resistor is mounted.
It is important to notice that after assembly the external reactance of $L_{c}$ and $C_{g}$ will be combined to internal reactance of $L$ and C. This combination can upgrade or downgrade the HF behavior of the component.

This is why we are displaying two sets of data:

- $\frac{[Z]}{R}$ versus frequency curves which aims to show at a glance the intrinsic HF performance of a given chip resistor
- S-parameters versus frequency curves relevant to chip resistor when assembled on ideal Z0 impedance transmission line

These lines are terminated with adapted source and load impedance respectively $Z_{s}$ and $Z_{I}$ with $Z_{0}=Z_{L}=Z_{s}$ (for others configurations please consult us).
Equivalent circuit for S-parameters:


S-parameters are computed taking into account all the resistive, inductive and capacitive elements $(Z$ total $)$ and $Z_{0}=Z_{L}=Z_{\mathrm{s}}=R$.

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## INTERNAL IMPEDANCE CURVES




Internal impedance curve for 0402 size ( $F$ and $P$ terminations)

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## INTERNAL IMPEDANCE CURVES



Internal impedance curve for 0402 size ( N and G terminations)


Internal impedance curve for 0603 size ( $F$ and $P$ terminations)

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## INTERNAL IMPEDANCE CURVES



## S-PARAMETER

## CH02016 (F and P Terminations)




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## S-PARAMETER

## CH0402 ( F and P Terminations)



CH0402 ( N and G Terminations)


CH 0402 wraparound $\left(\mathrm{Z}_{0}=\mathrm{Z}_{1}=\mathrm{Z}_{\mathrm{s}}=R=50 \Omega\right)$

## CH0603 (F and P Terminations)





CH 0402 wraparound $\left(\mathrm{Z}_{0}=\mathrm{Z}_{\mathrm{I}}=\mathrm{Z}_{\mathrm{s}}=R=100 \Omega\right)$

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## S-PARAMETER

## CH0603 (N and G Terminations)



CH 0603 wraparound $\left(\mathrm{Z}_{0}=\mathrm{Z}_{\mathrm{I}}=\mathrm{Z}_{\mathrm{s}}=R=50 \Omega\right)$


CH 0603 wraparound $\left(\mathrm{Z}_{0}=\mathrm{Z}_{1}=\mathrm{Z}_{\mathrm{s}}=R=100 \Omega\right)$

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